



Correction to: geometry assessment of ultra-short pulsed laser drilled micro-holes

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The original article contained a mistake.

Section 1 Introduction

- The unit of power density (W cm s^{-2}) is incorrect. Correctly, it must be W cm^{-2} .

Section 2.1 Material and machine

- The dash in 515-nm is not correct. Correctly, it must be 515 nm.

Section 2.2 Circular path laser drilling

- The b in the formula symbol of hatching distance l_b is not subscripted. Correctly, it must be l_b .
- The path of the laser beam is termed by d_{hatch} . Correctly, it must be d_{path} as in Fig. 1.
- The total diameter of the surface irradiated with the laser is termed by d_{hole} . Correctly, it must be d as in Fig. 1.
- The eq. (1) is incorrect. Correctly it must be $d_{\text{path}} = d - d_{\text{foc}}$

Caption in Fig. 1.

The FOV in the formula symbol of the length of the field of view IFOV is not subscripted. Correctly, it must be l_{FOV} .

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Section 3.4 Through-hole of 300 μm depth.

The dash in 300- μm is not correct. Correctly, it must be 300 μm .

Revised version of the bibliography in, as the current version is not consistent in the referencing style of the individual sources:

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The original article has been corrected.

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